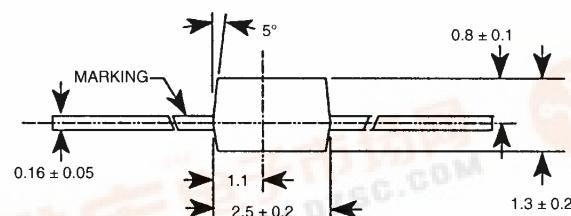
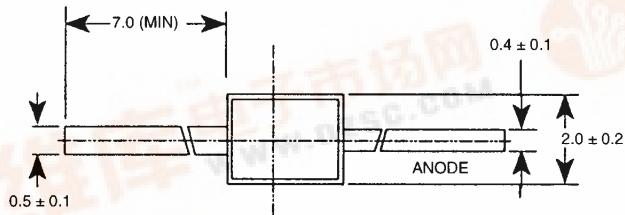




SURFACE MOUNT LED LAMP FLAT TYPE

RED QTLP282-2 CLEAR
YELLOW QTLP282-3 CLEAR
GREEN QTLP282-4 CLEAR
AlGaAs/RED QTLP282-7 CLEAR

PACKAGE DIMENSIONS



ST1709

NOTES:

1. ALL DIMENSIONS ARE IN MILLIMETERS
2. LEAD SPACING IS MEASURED WHERE THE LEADS EMERGE FROM THE PACKAGE
3. PROTRUDED RESIN UNDER THE FLANGE IS 1.5 mm (0.059") MAXIMUM

DESCRIPTION

These subminiature LED lamps are intended for high volume, low cost status indication on PCBs, and for backlighting keyboards and switches. They are compatible with vapor phase reflow or wave solder surface mount equipment. Available in "Gull-Wing" lead bend configuration. They have clear, flat lenses. Tape and reel options are also available.

FEATURE

- Subminiature package
- Flat package profile
- Wide viewing angle
- Lead bend options for surface mounting

ABSOLUTE MAXIMUM RATINGS ($T_A=25^\circ\text{C}$ unless otherwise specified)

PART NUMBER QTLP-	282-2	282-3	282-4	282-7
DC forward current (I_f)	30 mA	20 mA	30 mA	40 mA
Operating temperature range		-40°C to $+85^\circ\text{C}$		
Storage temperature range		-40°C to $+100^\circ\text{C}$		
Lead soldering time		5 seconds @ 260°C		
(at 1/16 inch (1.6 mm) from the bottom of lamp)				
Peak forward current	160 mA	160 mA	160 mA	200 mA
(at $f=1.0$ KHz, Duty factor=1/10)				
Power dissipation (P_d)	100 mW	85 mW	100 mW	110 mW
Recommended operating current (I_f , Rec)		20 mA		

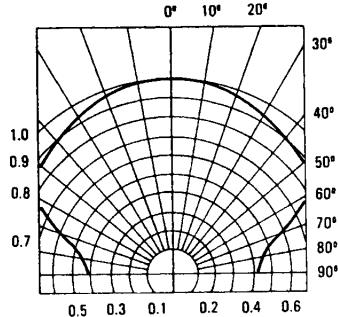
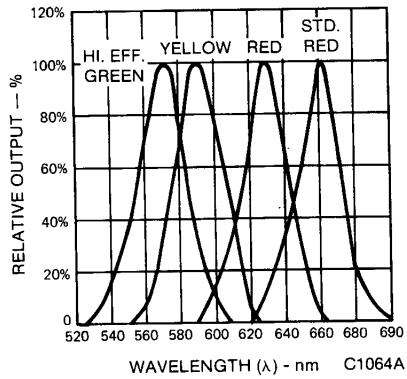


SURFACE MOUNT LED LAMP FLAT TYPE

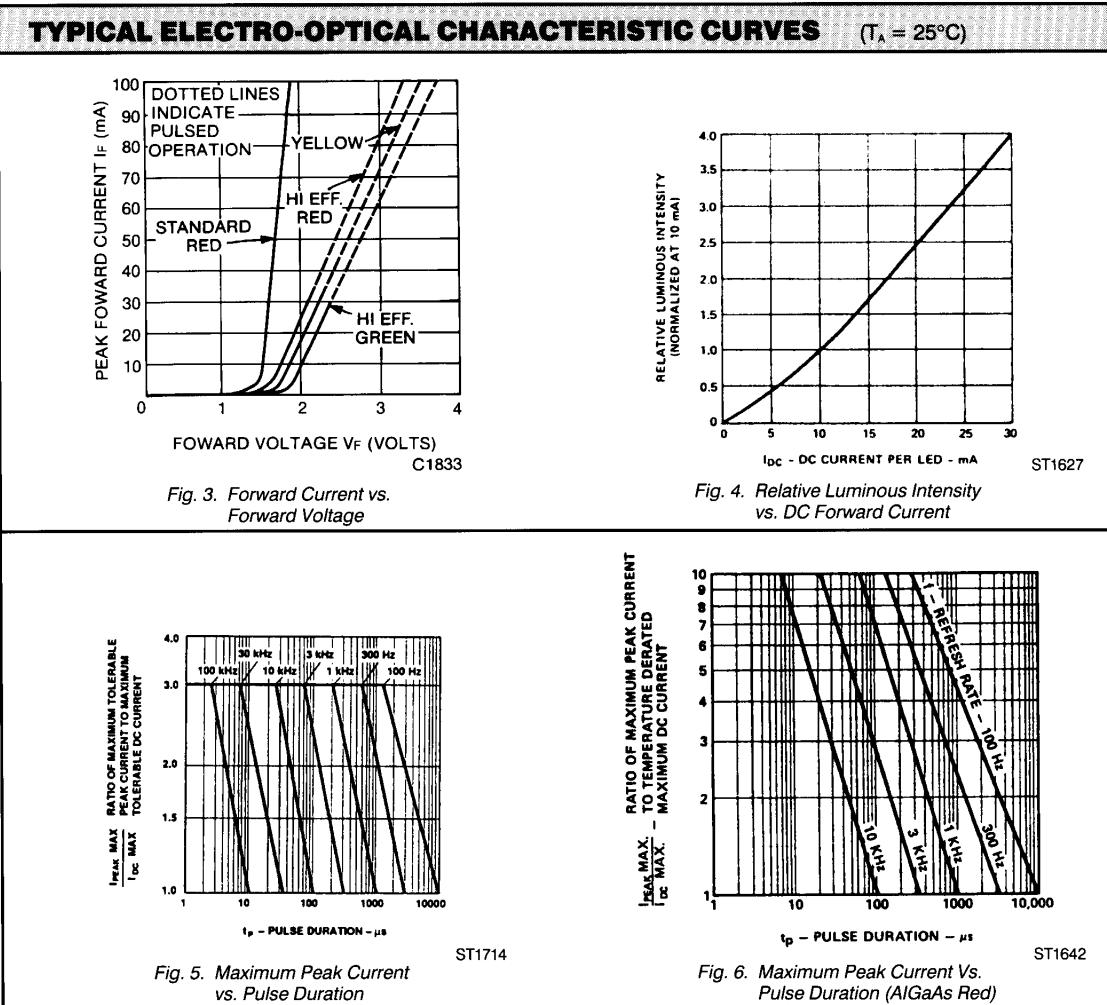
ELECTRO-OPTICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ Unless Otherwise Specified)

PART NUMBER	282-2	282-3	282-4	282-7	TEST CONDITIONS
Luminous intensity (mcd)					$I_F = 20 \text{ mA}$
minimum	1.5	3.5	1.0	11	
typical	5.6	6.0	5.6	17	
Forward voltage (V_F)					$I_F = 20 \text{ mA}$
minimum	1.7	1.7	1.7	1.7	
typical	2.0	2.0	2.1	2.0	
maximum	2.8	2.8	2.8	2.8	
Peak wavelength (nm)	640	585	565	660	$I_F = 20 \text{ mA}$
Spectral line half width (nm)	45	35	30	20	$I_F = 20 \text{ mA}$
Reverse breakdown voltage (V_R)	5	5	5	5	$I_R = 10 \mu\text{A}$
Viewing angle ($^\circ$)	150	150	150	150	$I_F = 20 \text{ mA}$

TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES ($T_A = 25^\circ\text{C}$)



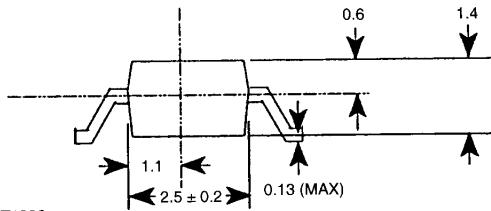
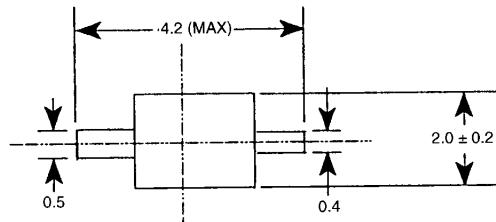
ST1711





SURFACE MOUNT OPTION FOR QTLP282-X FLAT TYPE LED LAMP GULL WING LEAD CONFIGURATION

LEAD BEND OPTIONS



ST1690

DESCRIPTION

These flat package LED lamps are encapsulated in an axial lead package with a clear lens. Automatic placement equipment can be used to mount these LEDs on PC boards. The lamps can be mounted using either batch or in line vapor phase reflow solder processes. Subminiature lamps are available in red, high efficiency red, yellow, and green.

FEATURES

- Gull Wing lead configuration for surface mount application
- Compatible with automatic placement equipment
- Compatible with vapor phase reflow solder processes.
- Supplied on tape and reel or in bulk packaging

ABSOLUTE MAXIMUM RATING ($T_A = 25^\circ\text{C}$ Unless Otherwise Specified)

Wave soldering temperature	260° for 3 seconds
(1.6 mm (0.063") from body)	
Surface Mount Reflow	
Soldering:	
Conductive IR	235° for 90 seconds
Vapor phase	215° for 3 minutes

ABSOLUTE MAXIMUM SOLDER RATINGS AND ELECTRICAL/OPTICAL CHARACTERISTICS

The absolute maximum ratings and electrical/optical specifications are identical to the basic catalogue device, except for the vapor phase soldering rating as specified above.



SURFACE MOUNT LED LAMP FLAT TYPE

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